

INFORMATION DISCLOSURE CITATION <small>(Use several sheets if necessary)</small>				Docket Number (Optional) BUR920030025US1		Application Number 10/605,440	
				Applicant(s) Robert Geffken et al.			
				Filing Date 09/30/2003		Group Art Unit Unknown 2818	
U.S. PATENT DOCUMENTS							
*EXAMINER INITIAL	REF	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
FOREIGN PATENT DOCUMENTS							
REF	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Translation	
						YES	NO
OTHER DOCUMENTS (<i>Including Author, Title, Date, Pertinent Pages, Etc.</i>)							
dhn		V. Arnal, J. Torres, P. Gayet, R. Gonella, P. Spinelli, M. Guillermet, J-P Reynard, G.C. Verove; "Integration of a 3 Level CuSiO ₂ Air Gap Interconnect for Sub 0.1 micron DMOS Technologies;" IEEE, 6/01, pages 298-300.					
EXAMINER				DATE CONSIDERED			
<i>Thao</i>				<i>04/26/05</i>			
EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP Section 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							

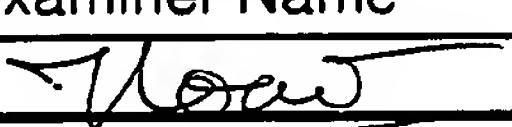
ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18

Stylesheet Version v18.0

Title of Invention	ADJUSTABLE SELF-ALIGNED AIR GAP DIELECTRIC FOR LOW CAPACITANCE WIRING													
Application Number :	10/605,440													
Confirmation Number:														
First Named Applicant:	Robert Geffken													
Attorney Docket Number:	BUR920030025US1													
Art Unit:	2818													
Examiner:	D. NGUYEN													
Search string:	(5324683 or 6150232 or 6200900 or 6281585 or 6329279 or 6423629 or 6472266 or 20020127844 or 20010023123).pn													
US Patent Documents														
Note: Applicant is not required to submit a paper copy of cited US Patent Documents														
init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass							
dha	1	5324683	1994-06-28	Fitch et al.		437	65							
/	2	6150232	2000-11-21	Chan et al.		438	421							
/	3	6200900	2001-03-13	Kitch		438	695							
/	4	6281585	2001-08-28	Bothra		257	758							
/	5	6329279	2001-12-11	Lee		438	619							
/	6	6423629	2002-07-23	Ahn et al.		438	622							
dha	7	6472266	2002-10-29	Yu et al.		438	241							
US Published Applications														
Note: Applicant is not required to submit a paper copy of cited US Published Applications														
init	Cite.No.	Pub. No.	Date	Applicant	Kind	Class	Subclass							
dha	1	20020127844	2002-09-12	Grill et al.		438	622							
dha	2	20010023123	2001-09-20	Kim		438	587							

Signature

Examiner Name	Date
	04/26/05